
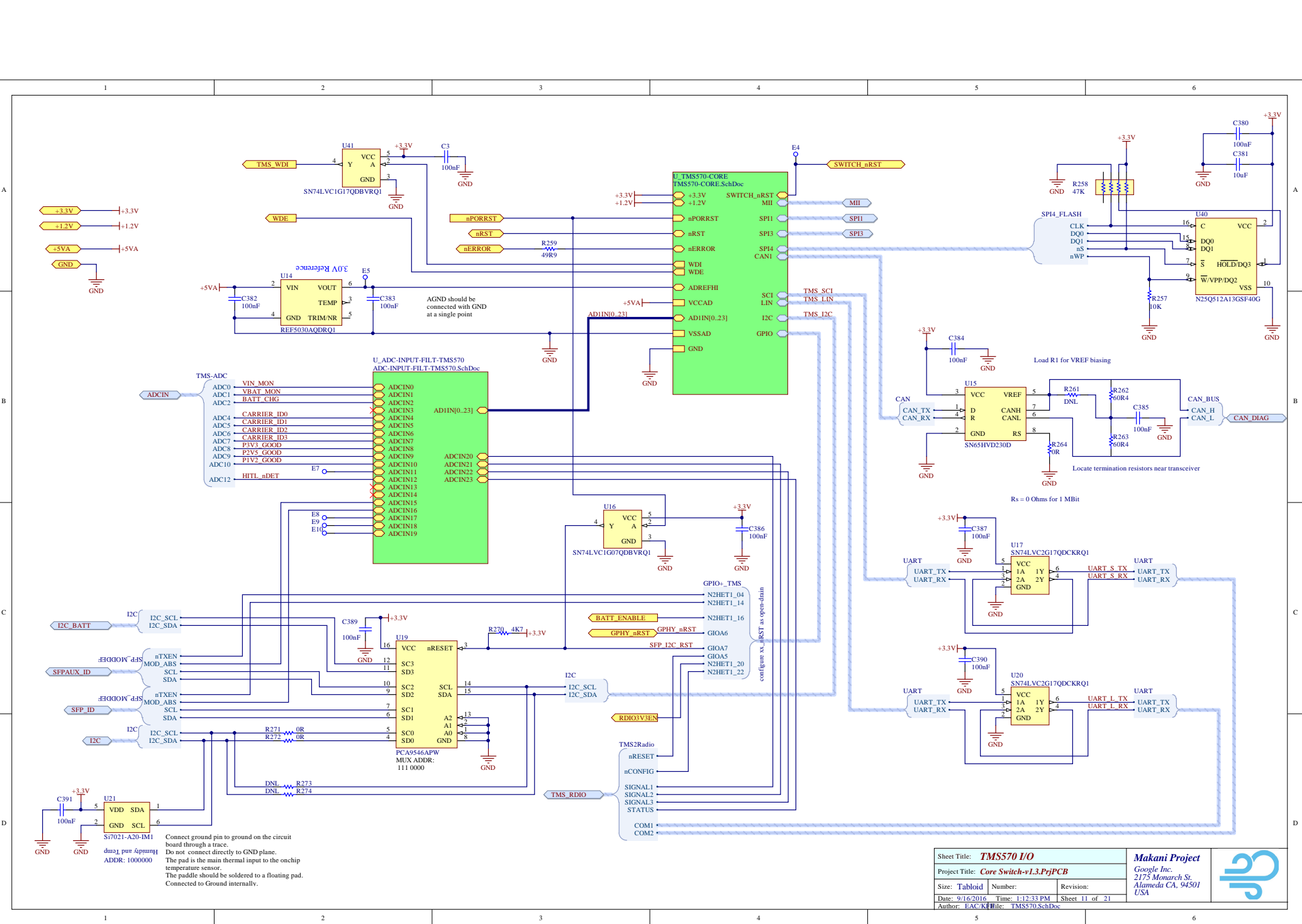



Sheet Title: AUXILIARY 1000BT			Makani Project Google Inc. 2175 Monarch St. Alameda CA, 94501 USA	
Project Title: Core Switch-v1.3.PrjPCB				
Size: Tabloid	Number:	Revision:		
Date: 9/16/2016	Time: 1:12:33 PM	Sheet 10 of 21		
Author: KFH	File: RJ-45.SchDoc			

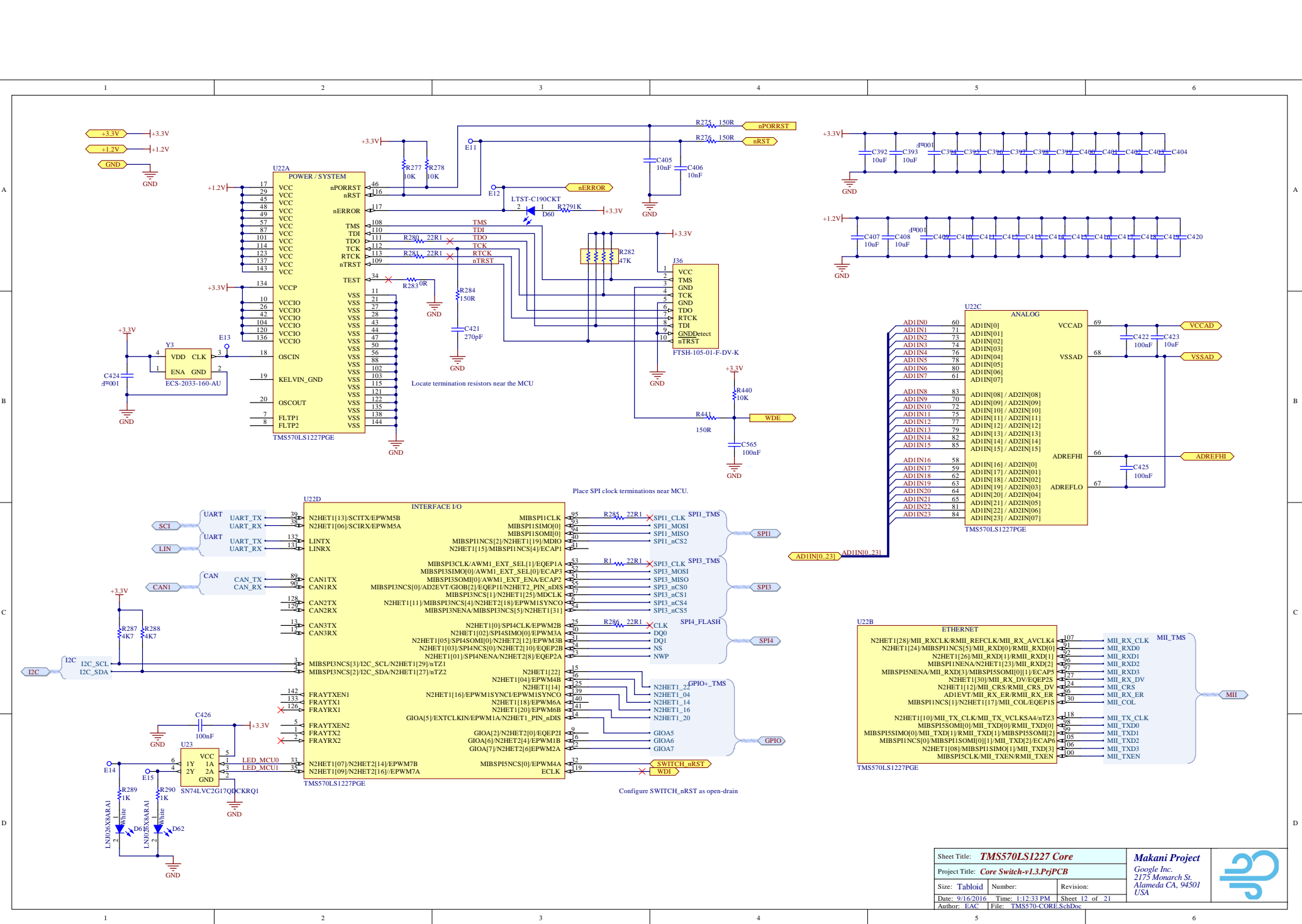


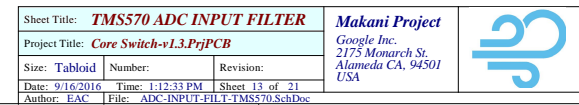


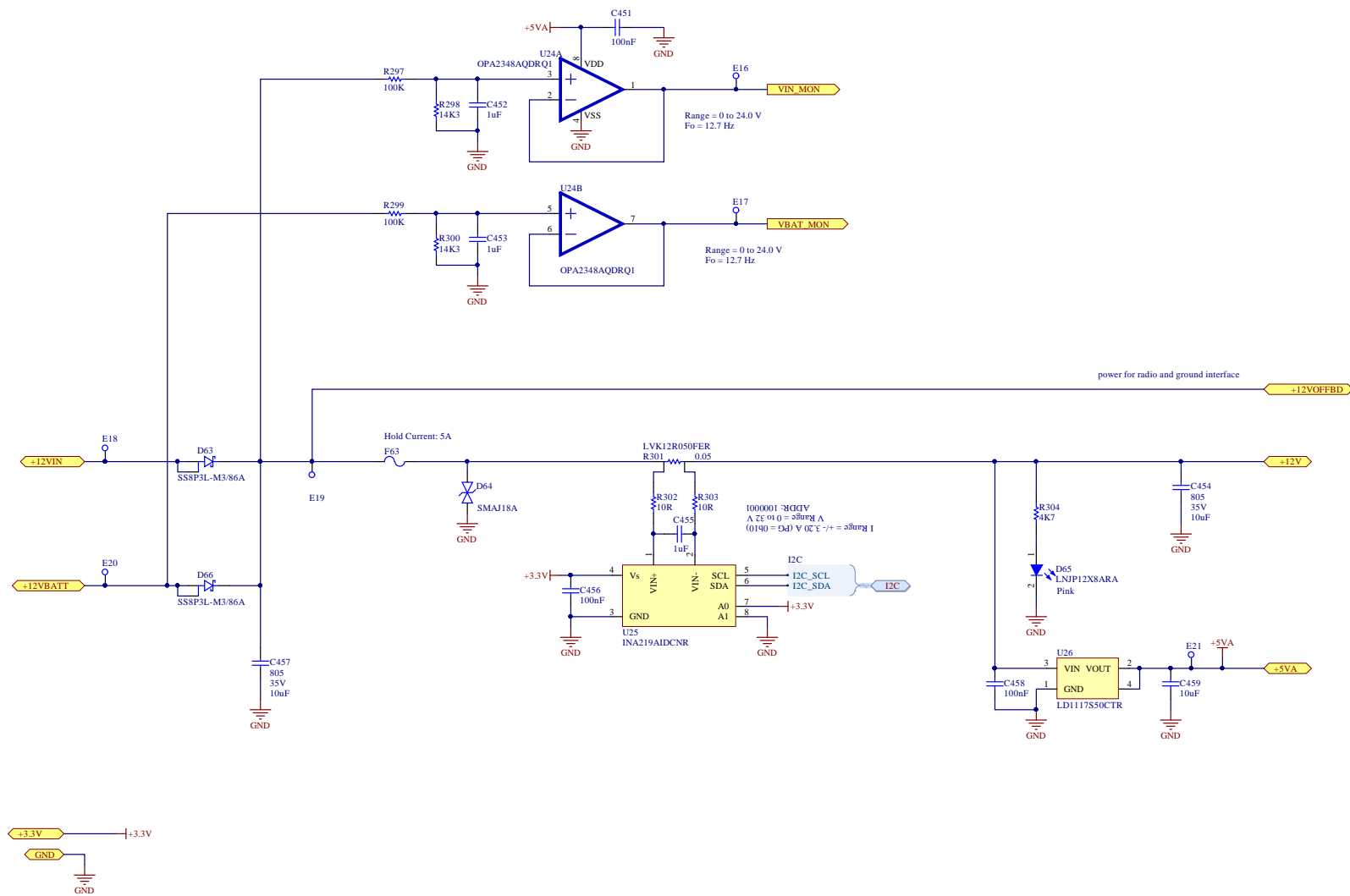
Connect ground pin to ground on the circuit board through a trace. Do not connect directly to GND plane. The pad is the main thermal input to the onchip temperature sensor. The paddle should be soldered to a floating pad. Connected to Ground internally.


Sheet Title: TMS570 I/O			Makani Project Google Inc. 2175 Monarch St. Alameda CA, 94501 USA	
Project Title: Core Switch-v1.3.PrjPCB				
Size: Tabloid	Number:	Revision:		
Date: 9/16/2016	Time: 1:12:33 PM	Sheet 11 of 21		
Author: EAC/K File: TMS570 SchDoc				









Sheet Title: Input Power			Makani Project Google Inc. 2175 Monarch St. Alameda Ca, 94501 USA	
Project Title: Core Switch-v1.3.PrjPCB				
Size: Tabloid	Number:	Revision:		
Date: 9/16/2016	Time: 1:12:33 PM	Sheet 14 of 21		
Author: KFH	File: Input-Power.SchDoc			



